<New Market Survey Report>

Solder Resist Report 2021

* Publication Date: November 12, 2021

* Format: A4 Size 171 Pages

* Price: JPY400,000- (a book & a CD)

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1. The Objective of the Publication

This report has been issued to provide basic data for relevant people in the industry in order to support them to establish marketing strategies by conducting detailed survey and analysis on the global Solder Resist market.

2. Period of survey target

Based on the data in 2020.

3. Survey method

Direct interviews, questionnaires, newspapers, academic and technical journals and internet survey

4. Survey items

Solder Resist (for PCBs)

5. Remarks

- •All of the numerical data in this report is prepared by JMS unless so noted.
- •The market sizes are all worldwide basis.
- •The data is a calendar year basis.
- The price market is calculated in USD. The exchange rates are as follows.
 *1USD=106.8Yen=1,170KRW=29.40NTD=6.70RMB=0.8765EUR=7.59HK\$

6. The classification of the application for Solder Resist

Computer	PCs, PC peripherals, large computers, storages, servers, etc.
Communications(Cellular Phone)	Mobile phones, wearables, tablets, wireless devices, etc.
Communications (Infrastructure)	Switches/routers, base station related equipment, information and communication technology equipment, telephone related equipment, etc.
Consumer	Audio/visual equipment, home appliances, etc.
Automotive	ECU board, car navigation, car audio, etc.
Industry & Medical	Factory equipment such as machine tools, building equipment such as elevators, railways, energy-related equipment, medical equipment, etc.
Military & Aerospace	Passenger planes, artificial satellites, fighters, etc.

7. Special notes

Abbreviations are used on graphs in this Report. The Official names are as follows.

Abbreviation		Official Name of Company
	Таіуо	Taiyo Holdings Co., Ltd.
	Tamura	TAMURA CORPORATION
	Showa	Showa Denko Materials Co., Ltd.
Japanese Manufacturers	Goo	Goo Chemical Co., Ltd.
	Sanwa	SANWA CHEMICAL INDUSTRIAL CO., LTD
	San-Ei	SAN-EI KAGAKU CO., LTD
	Ajinomoto	Ajinomoto Fine-Techno Co., Inc.
European & American Manufacturers	Sun Chemical	Sun Chemical Corporation
	Huntsman	Huntsman International LLC.
	Electra	Electra Polymers Limited
	Lackwerke	Lackwerke Peters GmbH & Co KG
Chinese Manufacturers	RongDa	Shenzhen RongDa Photosensitive Science & Technology Co., Ltd.
	Kuangshun	Jiangsu Kuangshun Photosensitivity New-Material Stock Co., Ltd.
Taiwanese Manufacturers	Eternal	Eternal Materials Co., Ltd.
	Nan Ya	Nan Ya Plastics Corporation

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